# RICOH RP604x Series

# Ultra-low Quiescent Current (I<sub>Q</sub> = 0.3 µA), 300 mA, Buck-Boost **DC/DC Converter**

No. EA-415-210709

#### OVERVIEW

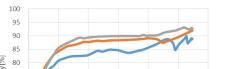
The RP604x is a buck-boost converter featuring a minimum supply current and a high efficiency at low-load. The device operates at the low operating quiescent current (I<sub>Q</sub> = 0.3 µA) to make the most of battery life for the battery driver operated intermittently.

#### KEY BENEFITS

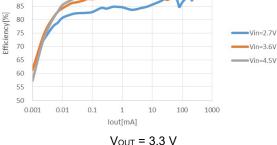
- The low supply current ( $I_Q = 0.3 \mu A$ ) can achieve making battery life longer and battery's size-reduction.
- Wide range of input voltage (1.8 V to 5.5 V) can support for every battery from a coin-type battery to a USB port.
- Selectable package: WLCSP-20-P2 or DFN(PLP)2730-12

#### KEY SPECIFICATIONS

- Input Voltage: 1.8 V to 5.5 V
- Output Voltage: 1.6 V to 5.2 V, 0.1 V step •
- Output Voltage Accuracy: ±1.5% •
- Maximum Output Current: 300 mA at Buck •
- Built-in Driver On-resistance (RP604Z, VIN = 3.6 V): • PMOS = Typ.0.12  $\Omega$ , NMOS = Typ. 0.12  $\Omega$
- Operating Quiescent Current (I<sub>Q</sub>): 0.3 µA
- Standby Current: 0.01 µA
- Protection Features: UVLO, OVP, LX Peak Current, and Thermal Shutdown



**TYPICAL CHARACTERISTICS** 



#### **OPTIONAL FUNCTIONS**

PACKAGES



WLCSP-20-P2 1.71 x 2.315 x 0.40<sup>(1)</sup> mm <sup>(1)</sup> maximum dimension

DFN(PLP)2730-12 2.70 x 3.00 x 0.6<sup>(1)</sup> mm

<sup>(1)</sup> maximum dimension

The auto-discharge function and the set output voltage (VSET) are user-selectable options.

Product Name	Auto-discharge Function	Vset
RP604xxx1A	Disable	1.6 V to 5.2 V
RP604xxx1B	Enable	(0.1 V step)

#### APPLICATIONS

- Wearable Appliances: SmartWatch, SmartBand, Healthcare
- Li-ion/Coin Battery-used Equipment •
- Low-power Wireless Communication Equipment: Bluetooth® Low Energy, ZigBee, WiSunm, ANT
- Low-power Devices for CPU, Memory, Sensor Device, Energy Harvesting

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# **SELECTION GUIDE**

The set output voltage, the auto-discharge function<sup>(1)</sup> and the package are user-selectable options.

#### **Selection Guide**

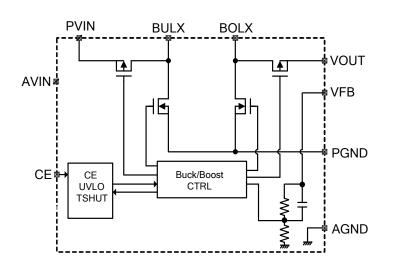
Product Name	Package	Quantity per Reel	Pb Free	Halogen Free
RP604Zxx1\$-E2-F	WLCSP-20-P2	5,000 pcs	Yes	Yes
RP604Kxx1\$-TR	DFN(PLP)2730-12	5,000 pcs	Yes	Yes

xx: Specify the set output voltage (V<sub>SET</sub>) within the range of 1.6 V (16) to 5.2 V (52) in 0.1 V steps.

\$: Specify the auto-discharge function.

Version	Auto-discharge Function	V <sub>SET</sub>
Α	Disable	1.6 V to 5.2 V
В	Enable	1.6 V 10 5.2 V

# **BLOCK DIAGRAM**



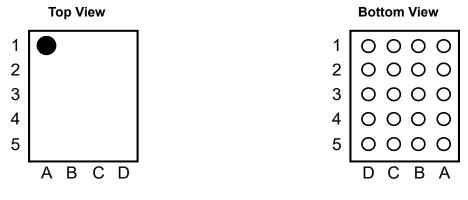
RP604xxx1A/ RP604xxx1B Block Diagram

<sup>&</sup>lt;sup>(1)</sup> Auto-discharge function quickly lowers the output voltage to 0 V, when the chip enable signal is switched from the active mode to the standby mode, by releasing the electrical charge accumulated in the external capacitor.



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# **PIN DESCRIPTIONS**

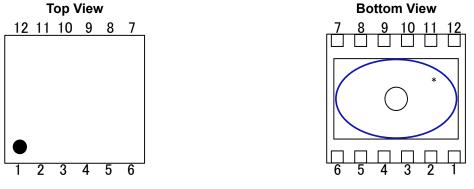


#### WLCSP-20-P2 Pin Configuration

Pin No.	Pin Name	Description
A5, B5, C5	VOUT	Output Voltage Pin
A4, B4, C4	BOLX	Boost Switching Output Pin
A3, B3, C3, D3	PGND	Power GND Pin
A2, B2, C2	BULX	Buck Switching Output Pin
A1, B1, C1	PVIN	Power Input Voltage Pin
D1	AVIN	Analog Power Input Voltage Pin
D2	CE	Chip Enable Pin, Active-high
D4	AGND	Analog GND Pin
D5	VFB	Output Voltage Feedback Pin

#### WLCSP-20-P2 Pin Description

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#### DFN(PLP)2730-12 Pin Configuration

Pin No.	Pin Name	Description	
1	AVIN	Analog Power Input Voltage Pin	
2	CE	Chip Enable Pin, Active-high	
3	PGND	Power GND Pin	
4	PGND	Power GND Pin	
5	AGND	Analog GND Pin	
6	VFB	Output Voltage Feedback Pin	
7	VOUT	Output Voltage Pin	
8	BOLX	Boost Switching Output Pin	
9	PGND	Power GND Pin	
10	PGND	Power GND Pin	
11	BULX	Buck Switching Output Pin	
12	PVIN	Power Input Voltage Pin	

#### DFN(PLP)2730-12 Pin Description

\* The tab on the bottom of the package shown by blue circle is a substrate potential (GND). It is recommended that this tab be connected to the ground plane on the board but it is possible to leave the tab floating.

<u>RP604x</u>

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# ABSOLUTE MAXIMUM RATINGS

Absolute Maximum Ratings				(GND = 0 V)	
Symbol	Parameter			Rating	Unit
VIN	A/PVIN Pin Volta	age		-0.3 to 6.5	V
VBULX	BULX Pin Voltag	je		-0.3 to V <sub>IN</sub> + 0.3	V
VBOLX	BOLX Pin Volta	ge		-0.3 to V <sub>OUT</sub> + 0.3	V
VCE	CE Pin Voltage			-0.3 to 6.5	V
Vout	VOUT Pin Volta	VOUT Pin Voltage			V
VFB	VFB Pin Voltage	9		-0.3 to 6.5	V
I <sub>LX</sub>	BULX/BOLX Pin	Output Current		900	mA
	Power	WLCSP-20-P2	JEDEC STD. 51-9	1490	mW
PD	Dissipation <sup>(1)</sup>	DFN(PLP)2730-12	JEDEC STD. 51-7	3100	mW
Tj	Junction Temperature Range			-40 to 125	°C
Tstg	Storage Temperature Range			-55 to 125	°C

#### ABSOLUTE MAXIMUM RATINGS

Electronic and mechanical stress momentarily exceeded absolute maximum ratings may cause permanent damage and may degrade the life time and safety for both device and system using the device in the field. The functional operation at or over these absolute maximum ratings are not assured.

# **RECOMMENDED OPERATING CONDITIONS**

#### **Recommended Operating Conditions**

Symbol	Parameter	Rating	Unit
Vin	Input Voltage	1.8 to 5.5	V
Та	Operating Temperature Range	−40 to 85	°C

#### RECOMMENDED OPERATING CONDITIONS

All of electronic equipment should be designed that the mounted semiconductor devices operate within the recommended operating conditions. The semiconductor devices cannot operate normally over the recommended operating conditions, even if they are used over such conditions by momentary electronic noise or surge. And the semiconductor devices may receive serious damage when they continue to operate over the recommended operating conditions.

<sup>(1)</sup> Refer to *POWER DISSIPATION* for detailed information.

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# **ELECTRICAL CHARACTERISTICS**

The specifications surrounded by  $\Box$  are guaranteed by design engineering at  $-40^{\circ}C \le Ta \le 85^{\circ}C$ .

Symbol	C Electrical Characteristics Parameter	Test Co	nditions/Comments	Min.	Тур.	Max.	Unit
Vout	Output Voltage	V <sub>IN</sub> = V <sub>CE</sub> =	= 3.6 V	x 0.985		x 1.015	V
Iq	Operating Quiescent Current	V <sub>IN</sub> = V <sub>CE</sub> = V <sub>SET</sub> = 3.3	= V <sub>OUT</sub> = 3.6 V, V at rest		0.3		μA
ISTANDBY	Standby Current	V <sub>IN</sub> = 5.5 \	/, V <sub>CE</sub> = 0 V		0.01	1	μA
Ісен	CE Pin Input Current, High	V <sub>IN</sub> = V <sub>CE</sub> =	= 5.5 V	-0.025	0	0.025	μA
ICEL	CE Pin Input Current, Low	V <sub>IN</sub> = 5.5 \	/, V <sub>CE</sub> = 0 V	-0.025	0	0.025	μA
Ілоптн	VFB Pin Input Current, High	V <sub>IN</sub> = V <sub>FB</sub> =	= 5.5 V, V <sub>CE</sub> = 0 V	-0.025	0	0.025	μA
Ivoutl	VFB Pin Input Current, Low	V <sub>IN</sub> = 5.5 \	V, $V_{CE} = V_{FB} = 0 V$	-0.025	0	0.025	μA
VOVP	OVP Threshold Voltage	V <sub>IN</sub> = 3.6 V	V, rising (detection)		6.0		V
VOVP	OVF Threshold Voltage	V <sub>IN</sub> = 3.6 V	√, falling (release)		5.5		V
RDISN	Auto-discharge NMOS On-resistance <sup>(1)</sup>	$V_{IN} = 3.6 V, V_{CE} = 0 V$			100		Ω
VCEH	CE Pin Input Voltage, High	V <sub>IN</sub> = 5.5 V		1.0			V
VCEL	CE Pin Input Voltage, Low	V <sub>IN</sub> = 2.0 \	/			0.4	V
		RP604Z	V <sub>IN</sub> = 3.6 V, I <sub>LX</sub> = -100 mA		0.12		Ω
Ronp	PMOS On-resistance	RP604K	V <sub>IN</sub> = 3.6 V, I <sub>LX</sub> = -100 mA		0.15		Ω
_		RP604Z	V <sub>IN</sub> = 3.6 V, I <sub>LX</sub> = −100 mA		0.12		Ω
Ronn	NMOS On-resistance	RP604K	V <sub>IN</sub> = 3.6 V, I <sub>LX</sub> = −100 mA		0.15		Ω
TTSD	Thermal Shutdown Threshold	Tj, rising (detection)			140		°C
T <sub>TSR</sub>	Temperature	Tj, falling (release)			100		°C
<b>t</b> start	Soft-start Time	$V_{IN} = V_{CE} = 3.6 \text{ V}$			20		ms
ILXLIM	LX Current Limit	V <sub>IN</sub> = V <sub>CE</sub> =	= 3.6 V	600	900		mA
VUVLOF		$V_{IN} = V_{CE},$	falling (detection)	1.40	1.50	1.65	V
VUVLOR	UVLO Threshold Voltage	$V_{IN} = V_{CE}$ ,	rising (release)	1.55	1.65	1.80	V

All test items listed under Electrical Characteristics are done under the pulse load condition (Tj  $\approx$  Ta = 25°C). Unless otherwise noted, the test runs with "Open-loop Control" (GND = 0 V).

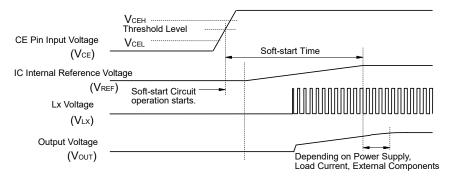
(1) RP604xxx1B only

# THEORY OF OPERATION

# Soft-start Time

#### Starting-up with CE Pin

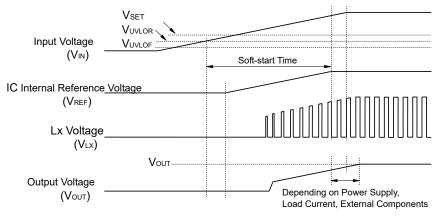
The IC starts to operate when the CE pin voltage (V<sub>CE</sub>) exceeds the threshold voltage. The threshold voltage is preset between CE "H" input voltage (V<sub>CEH</sub>) and CE "L" input voltage (V<sub>CEL</sub>). After the start-up of the IC, soft-start circuit starts to operate. Then, after a certain period of time, the reference voltage (V<sub>REF</sub>) in the IC gradually increases up to the specified value. Switching starts when V<sub>REF</sub> reaches the preset voltage, and after that the output voltage rises accompanying V<sub>REF</sub>'s increase. Soft-start time (t<sub>START</sub>) starts when soft-start circuit is activated, and ends when the reference voltage reaches the specified voltage. Soft start time is not always equal to the turn-on speed of the DC/DC converter. Note that the turn-on speed could be affected by the power supply capacity, the output current, the inductance value and the C<sub>OUT</sub> value.

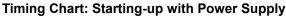


#### Timing Chart: Starting-up with CE Pin

#### Starting-up with Power Supply

After the power-on, when V<sub>IN</sub> exceeds the UVLO released voltage (V<sub>UVLOR</sub>), the IC starts to operate. Then, soft-start circuit starts to operate and after a certain period of time, V<sub>REF</sub> gradually increases up to the specified value. Switching starts when V<sub>REF</sub> reaches the preset voltage, and after that the output voltage rises accompanying V<sub>REF</sub>'s increase. Soft-start time starts when soft-start circuit is activated, and ends when V<sub>REF</sub> reaches the specified voltage. Note that the turn-on speed of V<sub>OUT</sub> could be affected by the power supply capacity, the output current, the inductance value, the C<sub>OUT</sub> value and the turn-on speed of V<sub>IN</sub> determined by C<sub>IN</sub>.





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# Undervoltage Lockout (UVLO) Circuit

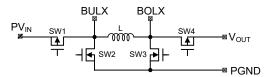
If the V<sub>IN</sub> becomes lower than the UVLO detector threshold (V<sub>UVLOF</sub>), the UVLO circuit starts to operate, V<sub>REF</sub> stops, and P-channel and N-channel built-in switch transistors turn "OFF". As a result, V<sub>OUT</sub> drops according to the C<sub>OUT</sub> capacitance value and the load. To restart the operation, V<sub>IN</sub> needs to be higher than V<sub>UVLOR</sub>.

# **Overvoltage Protection (OVP) Circuit**

If the  $V_{OUT}$  becomes higher than the OVP detector threshold ( $V_{OVP}$ ), the OVP circuit starts to operate, P-channel and N-channel built-in switch transistors turn "OFF". As a result,  $V_{OUT}$  drops according to the  $C_{OUT}$  capacitance value and the load.

# **Overcurrent Protection Circuit**

Overcurrent protection circuit supervises the inductor peak current (the peak current flowing through Pch Tr (SW1) in each switching cycle, and if the current exceeds the BULX current limit ( $I_{LXLIM}$ ), it turns off Pch Tr (SW1).  $I_{LXLIM}$  of the RP604x is set to Typ. 0.9 A.



Simplified Diagram of Output Switches

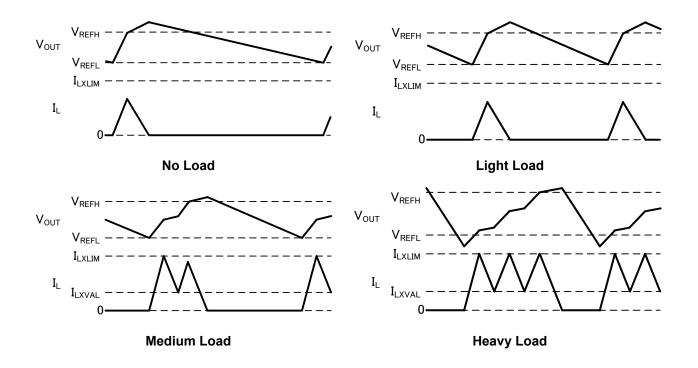
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#### VFM Mode

The VFM (Variable Frequency Modulation) mode is adopted as a switching method to achieve a high efficiency under light load conditions. A switching frequency varies depending on values of input voltage ( $V_{IN}$ ), output voltage ( $V_{OUT}$ ), and output current ( $I_{OUT}$ ). Check the actual characteristics to avoid the switching noise.

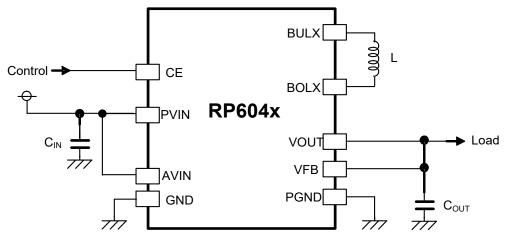
A switching starts when  $V_{OUT}$  drops below the lower-limit reference voltage ( $V_{REFL}$ ). When  $V_{OUT}$  exceeds the upper-limit reference voltage ( $V_{REFH}$ ), a constant voltage is output by a hysteresis control which stops the switching.

In order to operate within the rated characteristic of inductor and avoid the deteriorated band frequency of DC superimposed characteristics, when the inductor current ( $I_L$ ) exceeds LX current limit ( $I_{LXLIM}$ ), the operation shifts to off-cycle. And when  $I_L$  drops below the valley current limit ( $I_{LXVAL}$ ), the operation shifts to on-cycle.



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# **APPLICATION INFORMATION**



**RP604x Typical Application Circuit** 

# **Recommended External Components**

Symbol	Description	
CIN	10 μF or more, Ceramic Capacitor	
Соит	22 μF, Ceramic Capacitor	
L	2.2 μH, Inductor	

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# **TECHNICAL NOTES**

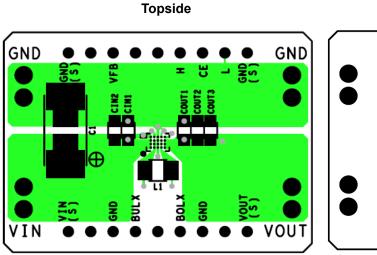
The performance of a power source circuit using this device is highly dependent on a peripheral circuit. A peripheral component or the device mounted on PCB should not exceed a rated voltage, a rated current or a rated power. When designing a peripheral circuit, please be fully aware of the following points. Refer to *PCB Layout* below.

- Use ceramic capacitors with a low equivalent series resistance (ESR), considering the bias characteristics and input/ output voltage.
- When the built-in switches are turned off, the inductor may generate a spike-shaped high voltage. Use the high-breakdown voltage capacitor (C<sub>OUT</sub>) which output voltage is 1.5 times or more than the set output voltage.
- Use an inductor that has a low DC resistance, has an enough tolerable current and is less likely to cause magnetic saturation. If the inductance value is extremely small, the peak current of L<sub>x</sub> may increase. When the peak current of L<sub>x</sub> reaches to the L<sub>x</sub> limit current (I<sub>LXLIM</sub>), overcurrent protection circuit starts to operate. When selecting the inductor, consider the peak current of LX pin (I<sub>LXMAX</sub>).
- When an intermediate voltage other than V<sub>IN</sub> or GND is input to the CE pin, a supply current may be increased with a through current of a logic circuit in the IC. The CE pin is neither pulled up nor pulled down, therefore an operation is not stable at open.

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# PCB Layout

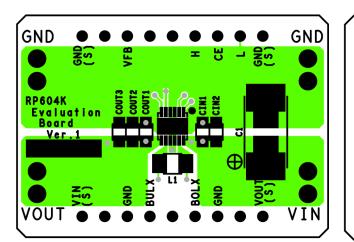
RP604Z (Package: WLCSP-20-P2) PCB Layout

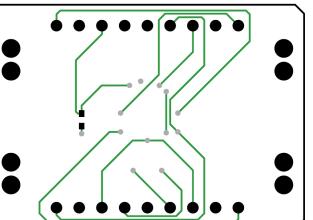


# Backside

# RP604K (Package: DFN(PLP)2730-12) PCB Layout

Topside





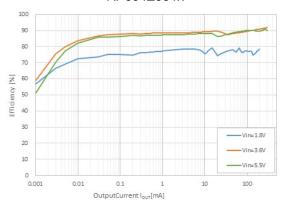
Backside

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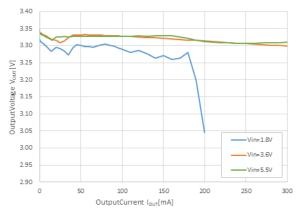
# **TYPICAL CHARACTERISTICS**

Note: Typical Characteristics are intended to be used as reference data; they are not guaranteed. 1) Output Current vs. Efficiency with Different Input Voltages

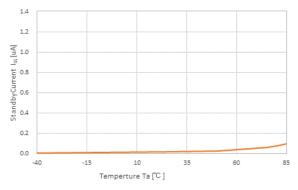
RP604Z331x



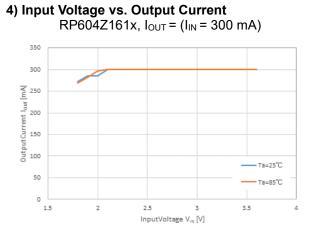
2) Output Current vs. Output Voltage with Different Input Voltages RP604Z331x



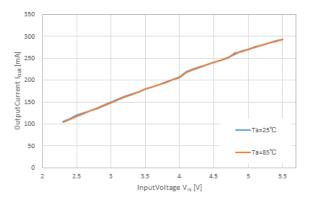
3) Temperature vs. Standby Current RP604Z331x,V<sub>IN</sub> = 5.5 V

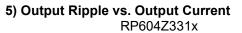


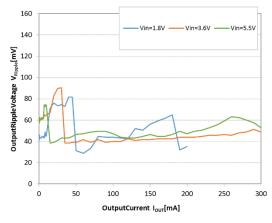
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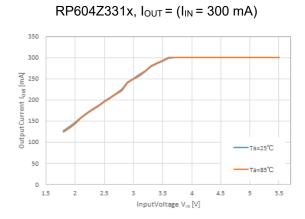




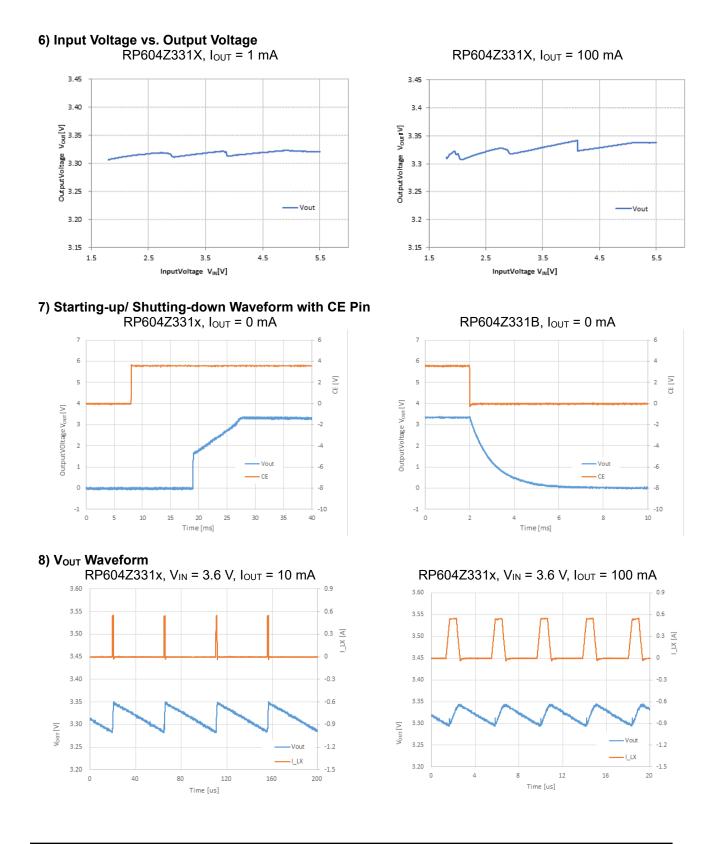




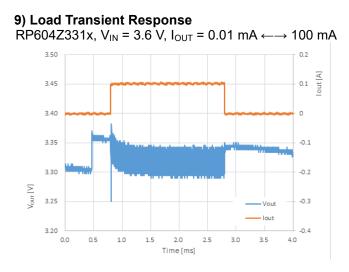




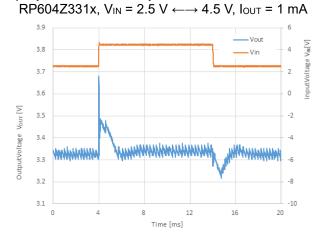
No. EA-415-210709



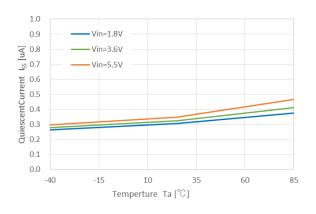
No. EA-415-210709



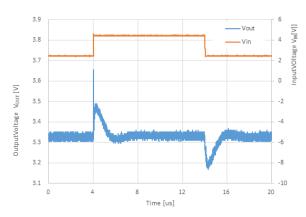
10) Input Transient Response



11) Temperature vs. Supply Current



RP604Z331x, V\_{IN} = 2.5 V  $\longleftrightarrow$  4.5 V, I\_{OUT} = 100 mA



# **POWER DISSIPATION**

# WLCSP-20-P2

Ver. A

The power dissipation of the package is dependent on PCB material, layout, and environmental conditions. The following measurement conditions are based on JEDEC STD. 51-9.

#### **Measurement Conditions**

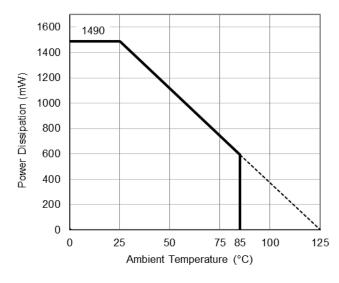
ltem	Measurement Conditions	
Environment	Mounting on Board (Wind Velocity = 0 m/s)	
Board Material	Glass Cloth Epoxy Plastic (Four-Layer Board)	
Board Dimensions	101.5 mm x 114.5 mm x 1.6 mm	
Copper Ratio Outer Layers (First and Fourth Layers): 60% Inner Layers (Second and Third Layers): 100%		

#### **Measurement Result**

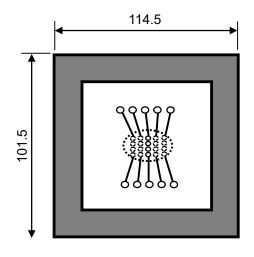
(Ta = 25°C, Tjmax = 125°C)

Item	Measurement Result	
Power Dissipation	1490 mW	
Thermal Resistance ( $\theta$ ja)	θja = 67 °C/W	

 $\theta$ ja: Junction-to-Ambient Thermal Resistance



Power Dissipation vs. Ambient Temperature

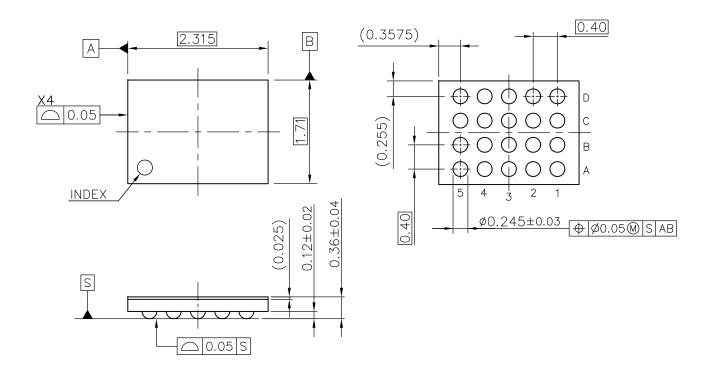


#### **Measurement Board Pattern**

# PACKAGE DIMENSIONS

# WLCSP-20-P2

Ver. A



WLCSP-20-P2 Package Dimensions (Unit: mm)

# RICOH

# WLCSP

VI-160823

No.	Inspection Items	Inspection Criteria	Figure
1	Package chipping	A≥0.2mm is rejected B≥0.2mm is rejected C≥0.2mm is rejected And, Package chipping to Si surface and to bump is rejected.	B ↓ C
2	Si surface chipping	A≥0.2mm is rejected B≥0.2mm is rejected C≥0.2mm is rejected But, even if A≥0.2mm, B≤0.1mm is acceptable.	B t C
3	No bump	No bump is rejected.	
4	Marking miss	To reject incorrect marking, such as another product name marking or another lot No. marking.	
5	No marking	To reject no marking on the package.	
6	Reverse direction of marking	To reject reverse direction of marking character.	
7	Defective marking	To reject unreadable marking. (Microscope: X15/ White LED/ Viewed from vertical direction)	
8	Scratch	To reject unreadable marking character by scratch. (Microscope: X15/ White LED/ Viewed from vertical direction)	
9	Stain and Foreign material	To reject unreadable marking character by stain and foreign material. (Microscope: X15/ White LED/ Viewed from vertical direction)	

# **POWER DISSIPATION**

# DFN(PLP)2730-12

Ver. A

The power dissipation of the package is dependent on PCB material, layout, and environmental conditions. The following measurement conditions are based on JEDEC STD. 51-7.

#### **Measurement Conditions**

Item	Measurement Conditions
Environment	Mounting on Board (Wind Velocity = 0 m/s)
Board Material	Glass Cloth Epoxy Plastic (Four-Layer Board)
Board Dimensions	76.2 mm × 114.3 mm × 0.8 mm
Copper Ratio	Outer Layer (First Layer): Less than 95% of 50 mm Square Inner Layers (Second and Third Layers): Approx. 100% of 50 mm Square Outer Layer (Fourth Layer): Approx. 100% of 50 mm Square
Through-holes	φ 0.3 mm × 23 pcs

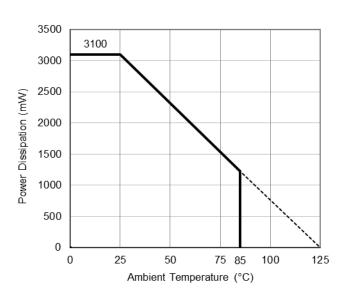
#### **Measurement Result**

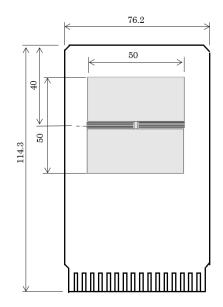
(Ta = 25°C, Tjmax = 125°C) ltem **Measurement Result Power Dissipation** 3100 mW Thermal Resistance (θja) θja = 32°C/W Thermal Characterization Parameter (ψjt)  $\psi$ jt = 8°C/W

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θja: Junction-to-Ambient Thermal Resistance

wit: Junction-to-Top Thermal Characterization Parameter





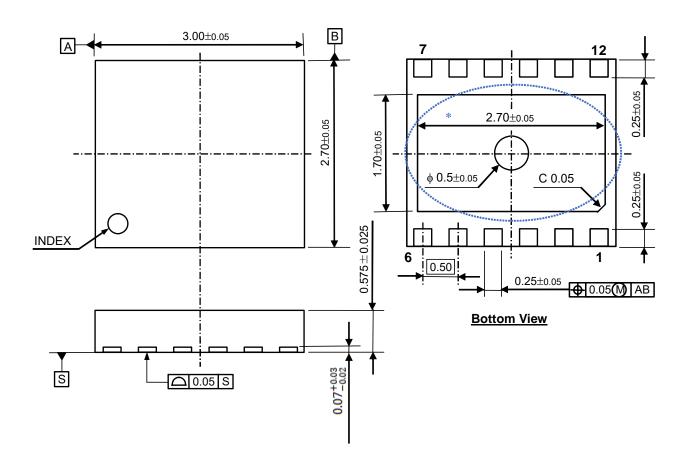
#### **Power Dissipation vs. Ambient Temperature**

**Measurement Board Pattern** 

# PACKAGE DIMENSIONS

# DFN(PLP)2730-12

Ver. A



DFN(PLP)2730-12 Package Dimensions (Unit: mm)

<sup>\*</sup>The tab on the bottom of the package shown by blue circle is a substrate potential (GND). It is recommended that this tab be connected to the ground plane on the board but it is possible to leave the tab floating.



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